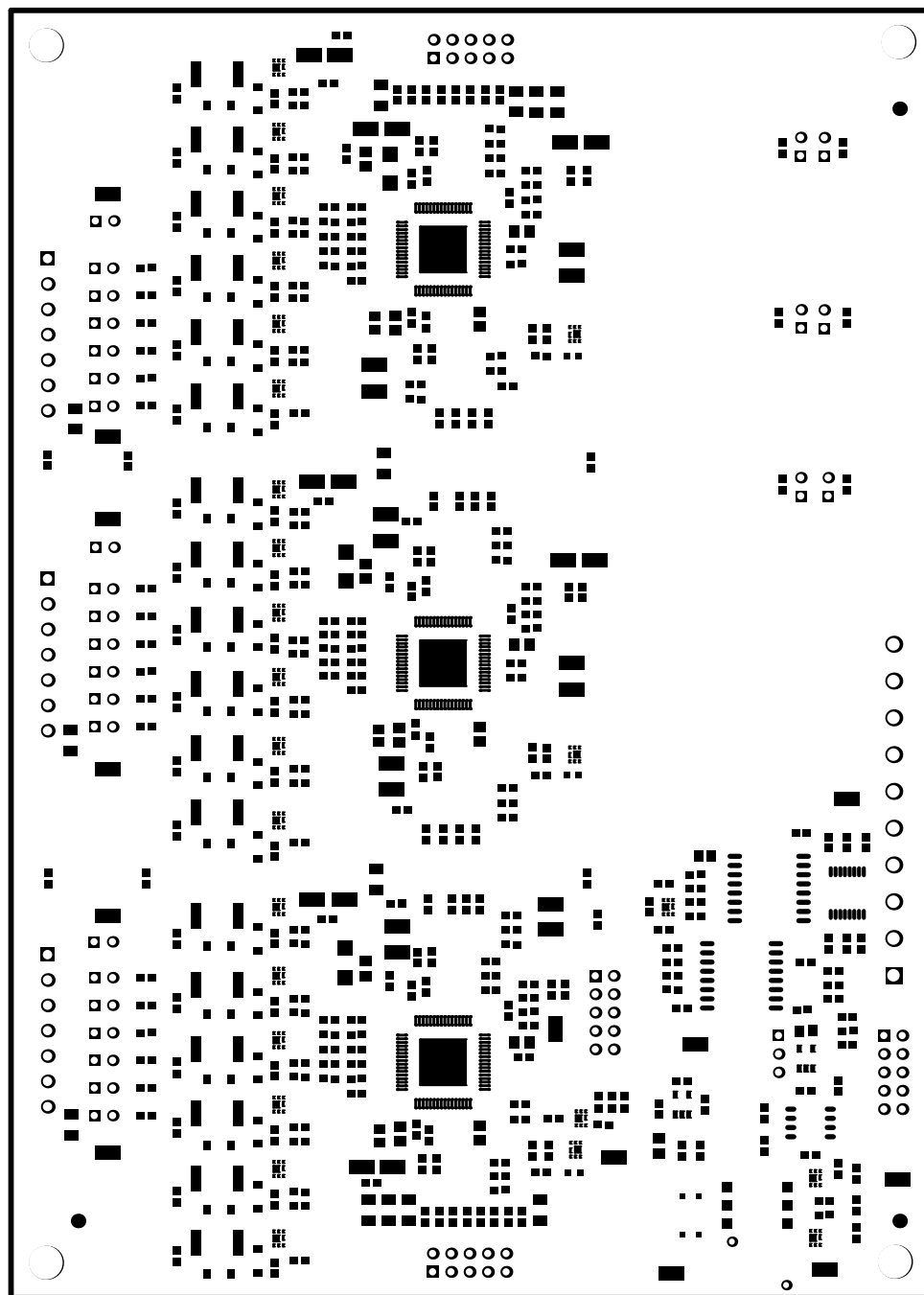
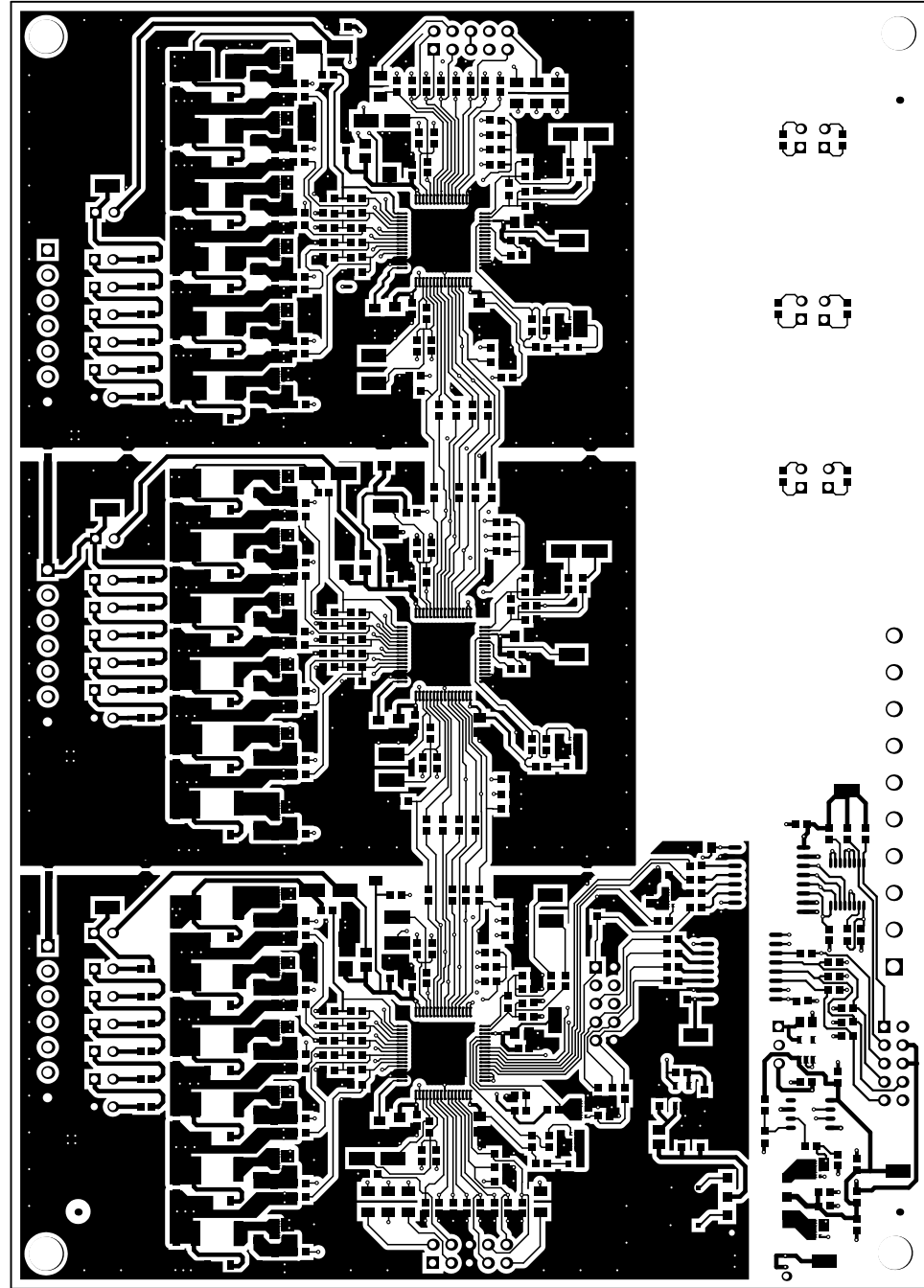


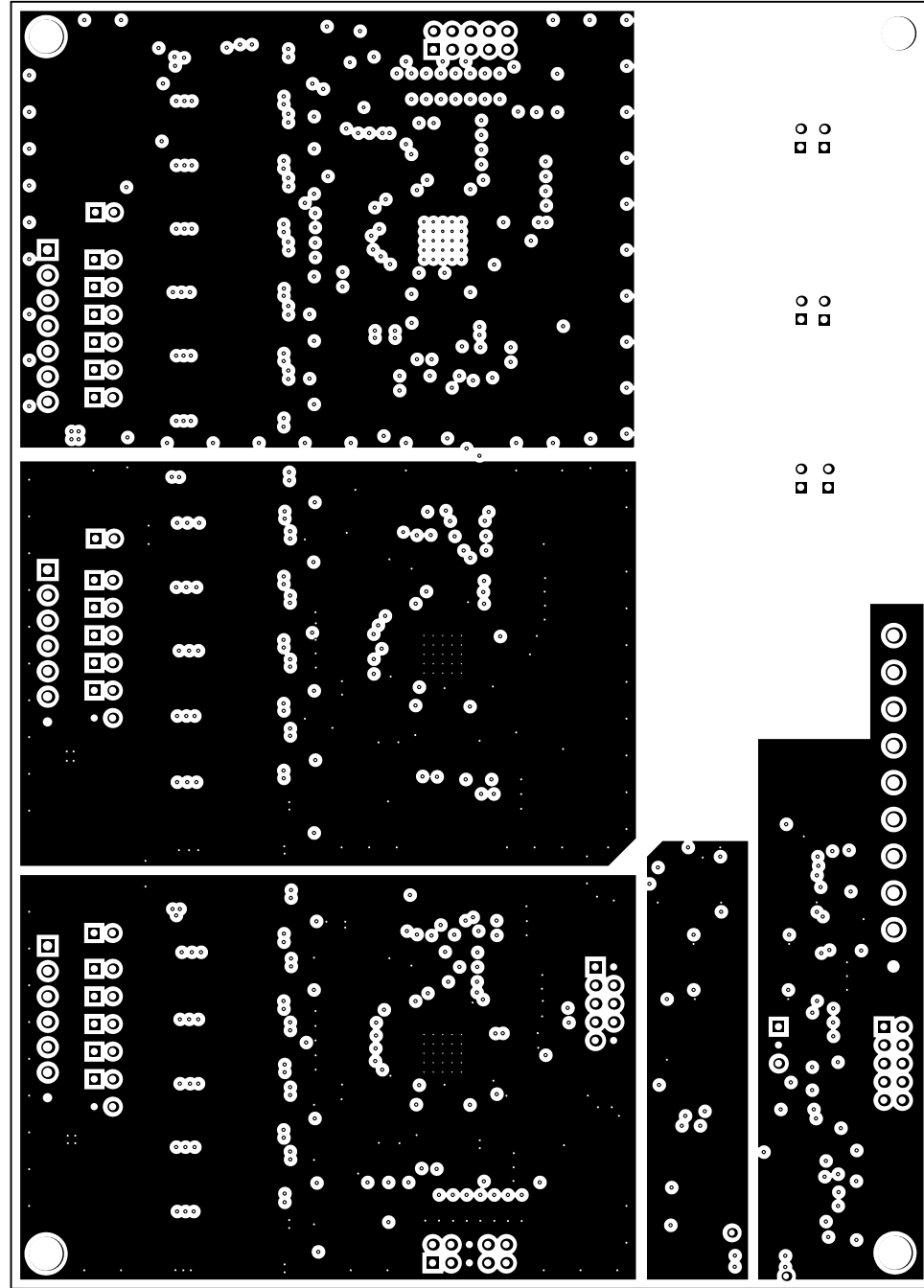
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TID		
PLOT NAME = Top Overlay	GENERATED : 10/21/2015 8:23:27 AM		TEXAS INSTRUMENTS



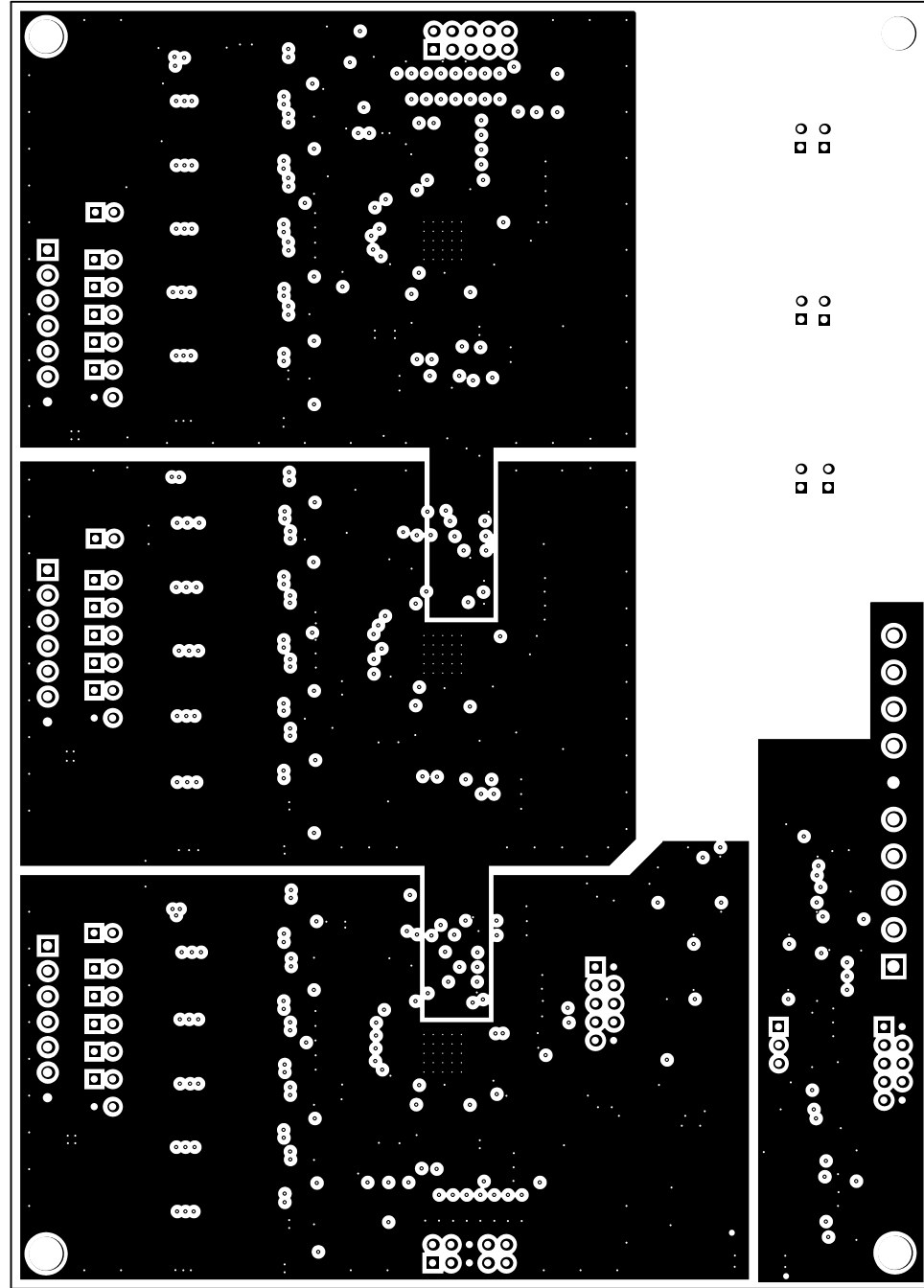
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TID		
PLOT NAME = Top Solder Mask	GENERATED : 10/21/2015 8:23:29 AM		TEXAS INSTRUMENTS



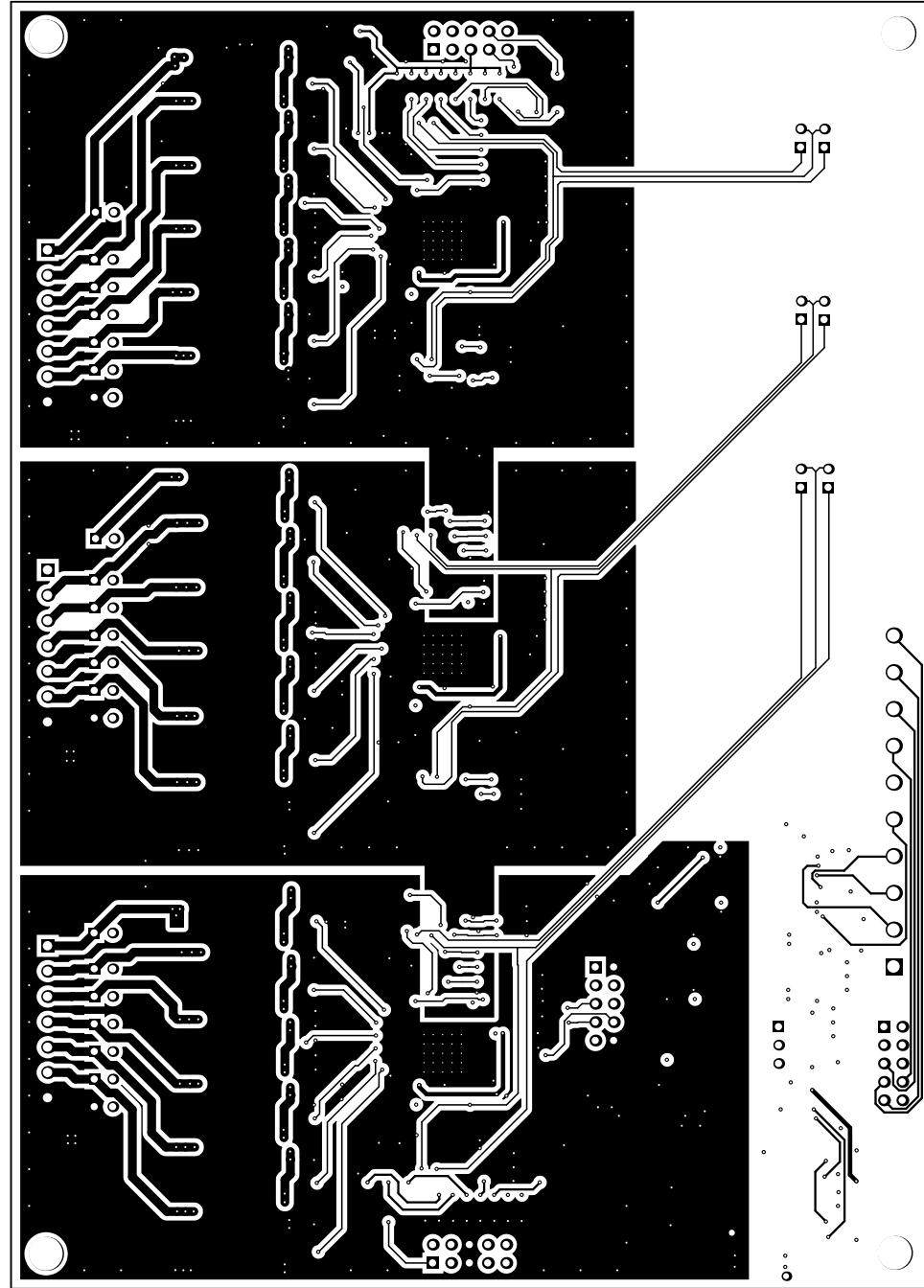
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TID		
PLOT NAME = Top Layer	GENERATED : 10/21/2015 8:23:30 AM		TEXAS INSTRUMENTS



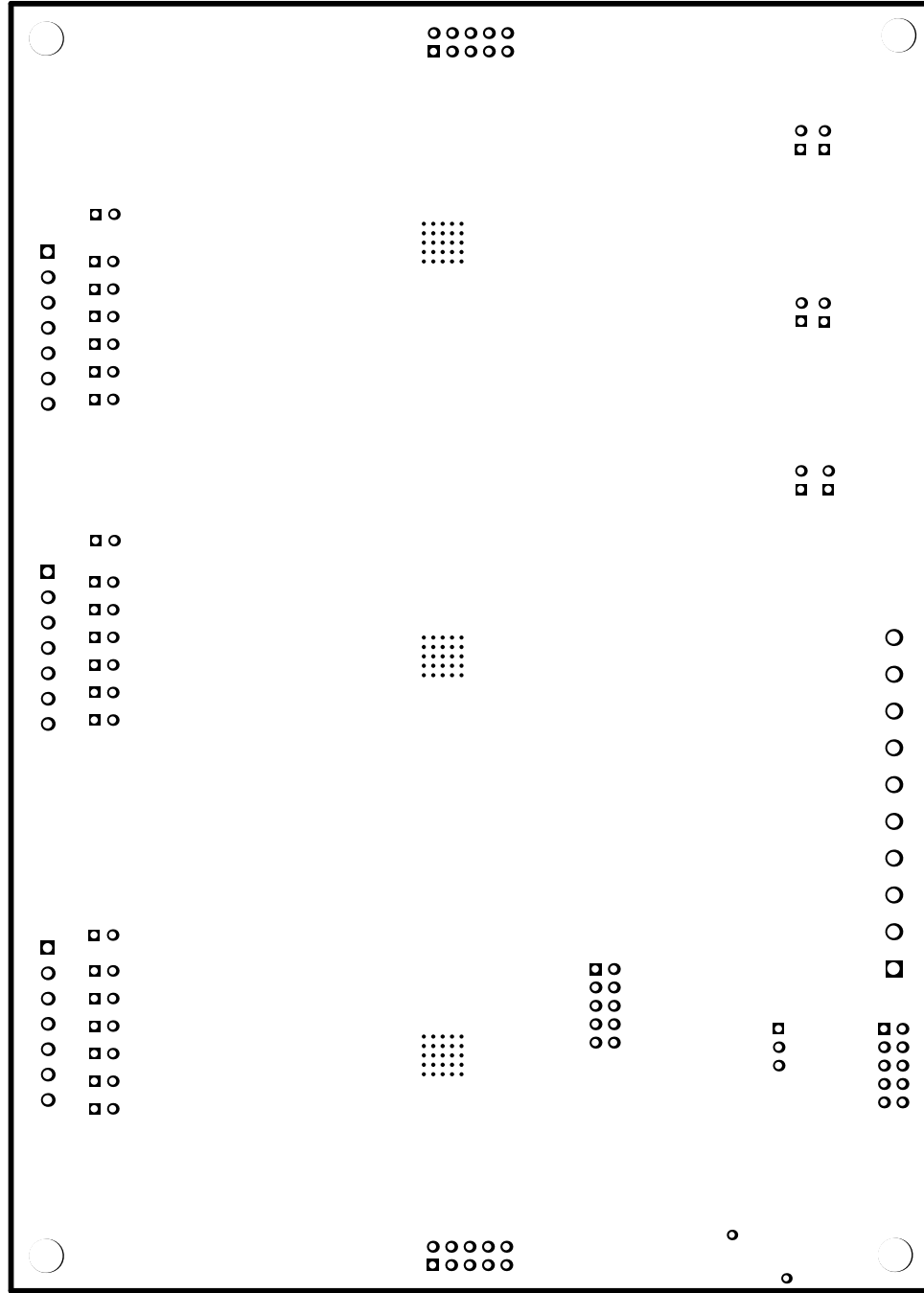
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 1	TID #: TID		
PLOT NAME = Signal Layer 1	GENERATED : 10/21/2015 8:23:31 AM		TEXAS INSTRUMENTS



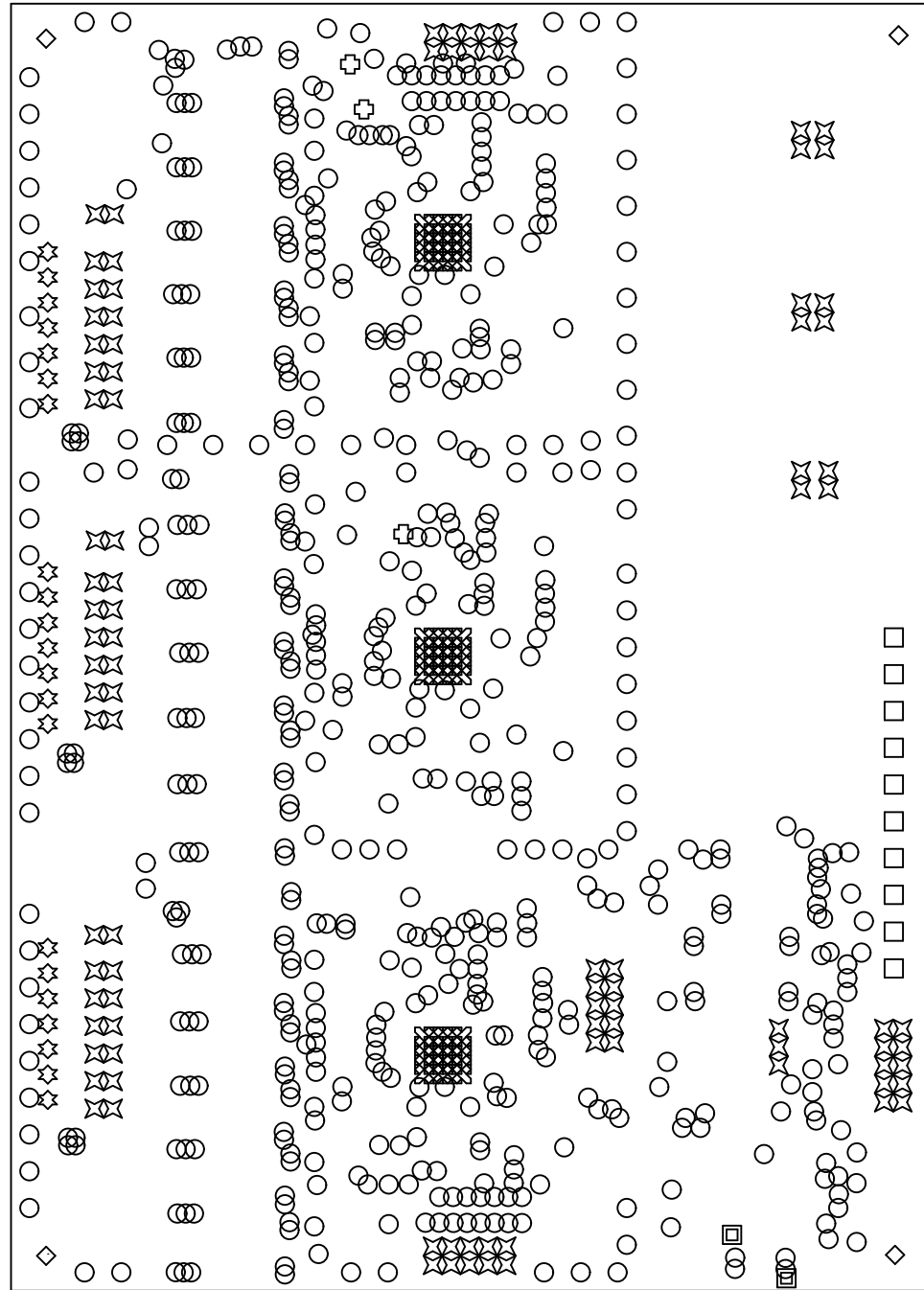
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 2	TID #: TID		
PLOT NAME = Signal Layer 2	GENERATED : 10/21/2015 8:23:31 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TID		
PLOT NAME = Bottom Layer	GENERATED : 10/21/2015 8:23:32 AM		TEXAS INSTRUMENTS

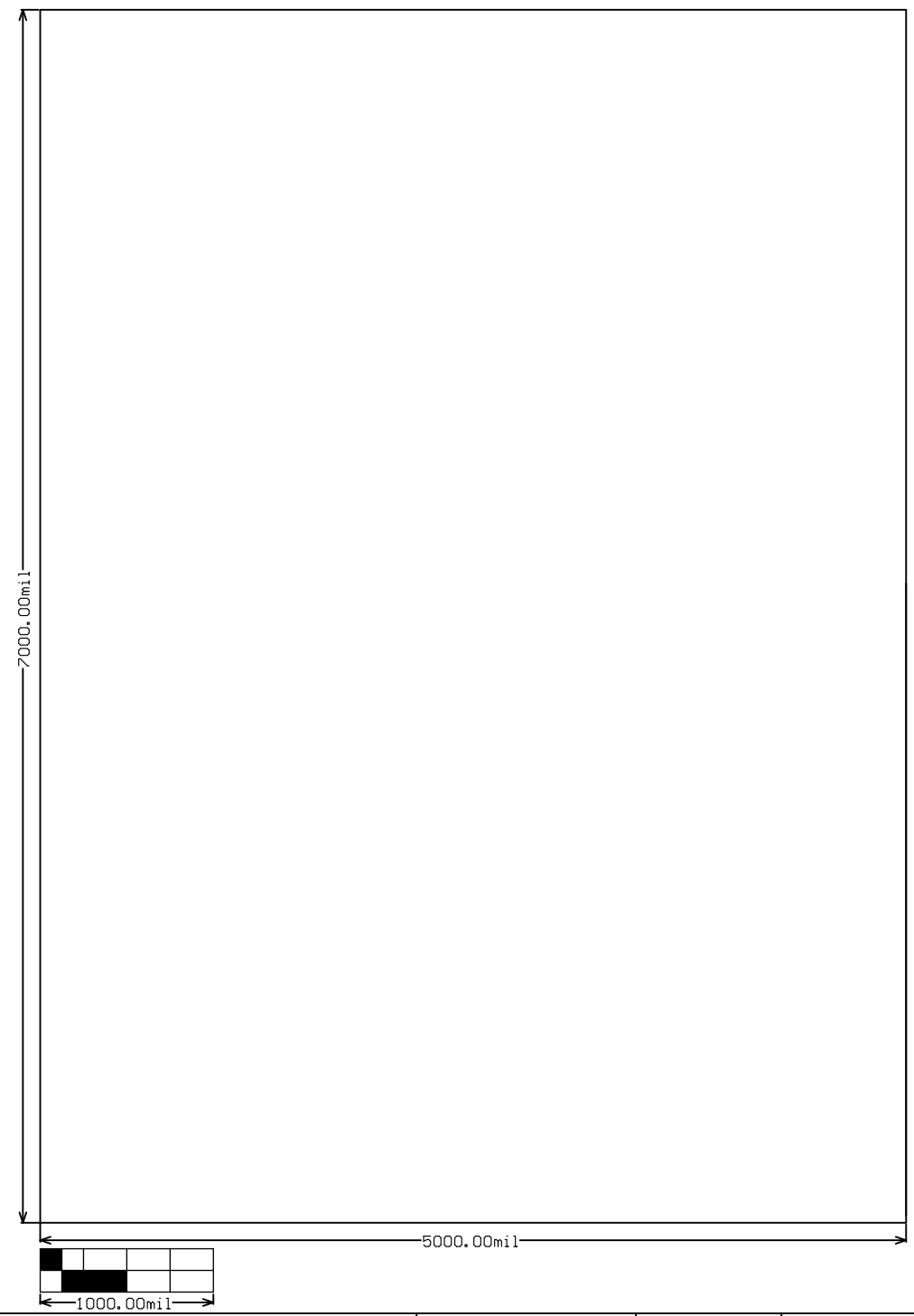


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TID		
PLOT NAME = Bottom Solder Mask	GENERATED : 10/21/2015 8:23:33 AM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
■	2	33.46mil (0.850mm)	PTH	Round
⊙	3	10.00mil (0.254mm)	PTH	Round
◇	4	185.04mil (4.700mm)	NPTH	Round
□	10	68.90mil (1.750mm)	PTH	Round
⊛	21	51.18mil (1.300mm)	PTH	Round
⊗	75	7.87mil (0.200mm)	PTH	Round
⊠	97	40.00mil (1.016mm)	PTH	Round
○	607	12.00mil (0.305mm)	PTH	Round
819 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TID		
PLOT NAME = Drill Drawing	GENERATED : 10/21/2015 8:23:34 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR763	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TID		
PLOT NAME = Board Dimensions	GENERATED : 10/21/2015 8:23:35 AM		TEXAS INSTRUMENTS

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